

### **SMD Molding Power Inductor**

### Features

- 1. Magnetically shielded construction, low DC resistance;
- The use of magnetic iron powder ensure capability for large current;
- 3. Low audible core noise:
- 4. Ideal for DC-DC converter applications in hand held personal computer and etc;
- 5、Frequency Range: up to 3.0MHz;
- 6、RoHS compliant。

### Applications

- 1、Smart phone、MID;
- Next-generation mobile devices with multifunction such as adding color TV and digital movie cameras;
- 3、Flat-screen TVs, blue-ray disc recorders, set top box;
- 4. Notebooks, desktop computers, servers, graphic cards;
- 5. Portable gaming devices, personal navigation systems, personal multimedia devices;
- 6. Automotive systems;
- 7、Telecomm base stations。

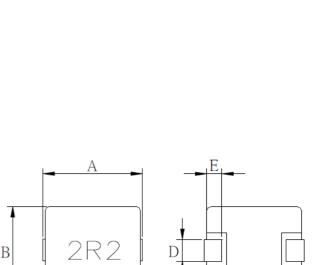
### ◆ Lead Free Part Numbering

CMLO 0530 H 2R2 M T T (1) (2) (3) (4) (5) (6) (7)

- (1) Series Type
- (2) Dimension: AXC
- (3) Material Code
- (4) Inductance:  $2R2=2.2\mu H$ ;

100=10μΗ; 101=100μΗ

- (5) Inductance Tolerance: M=±20%, Y=±30%
- (6) Company Code
- (7) Packaging: packed in embossed carrier tape





### Dimensions

Series	A±0.3(mm)	B±0.3 (mm)	C (mm)	D±0.1 (mm)	E±0.1 (mm)
CMLO0530H	5.4	5.2	3.0 Max	2.0	1.0

Rev.01 Page 1 of 7 www.cybermaxtech.com.cn



## **♦** Specification

Part Number	INDUCTANCE	Rdc (m Ω)		Test a	HEAT RATING CURRENT(Idc)	SATURATION CURRENT(Isat)			
Fait Number	Lo(   H)	Тур.	Max	condition	DC AMPS1 (Typ.)	DC AMPS2 (Typ.)			
CMLO0530H Series	CMLO0530H Series								
CMLO0530HR47MTT	0.47	5.0	7.4	100KHz/1V	12.0	16.0			
CMLO0530HR68MTT	0.68	9.0	12.0	100KHz/1V	8.5	14.0			
CMLO0530H1R0MTT	1.0	11.0	14.0	100KHz/1V	7.0	9.0			
CMLO0530H1R5MTT	1.5	20.0	25.0	100KHz/1V	6.0	8.2			
CMLO0530H2R2MTT	2.2	25.0	35.0	100KHz/1V	5.5	7.5			
CMLO0530H3R3MTT	3.3	28.0	38.0	100KHz/1V	5.0	5.5			
CMLO0530H4R7MTT	4.7	46.0	60.0	100KHz/1V	4.0	4.5			
CMLO0530H5R6MTT	5.6	53.0	63.0	100KHz/1V	4.0	4.0			
CMLO0530H6R8MTT	6.8	66.0	76.0	100KHz/1V	4.0	3.5			
CMLO0530H100MTT	10.0	108.0	128.0	100KHz/1V	2.8	2.5			

#### NOTES:

- 1. DC current (ldc) that will cause an approximate  $\triangle T$  of 40°C
- 2. DC current (Isat) that will cause Lo to drop approximately 20%
- 4. Operating Temperature Range -55°C to +150°C
- 5. The part temperature (ambient + temp rise) should not exceed 150°C under the worst operating conditions. Circuit design, component placement, PWB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.

Rev.01 Page 2 of 7 www.cybermaxtech.com.cn



## ◆ Reliability Test

Item	Specification and Requirement	Test Method			
	1. No case deformation or change in	1.Preheat: 155℃±5℃ , 60S±2S			
Solderability	apperarance	2.Tin: lead-free.			
	2. New solder coverage More than 90%	3.Temperature:245℃±5℃, flux 3.0S±0.5S.			
	1. No case deformation or change in	1. Acceleration: 100G			
Mechanical	apperarance	2. Pulse time:: 6ms			
shock	2. △L/Lo≦±10%	3. 3 times in each positive and negative direction of 3			
		mutual perpendicular directions			
	No case deformation or change in	1. The test samples shall be soldered to the board.			
	apperarance	Then it shall be submitted to below test conditions.			
	2. △L/Lo≦±10%	Fre. Range 10~55Hz			
Mechanical		Total Amplitude 1.5mm			
vibration		Sweeping Method 10Hz to 55Hz to 10Hz			
		Time For 2 hours on each X,Y,Z axis.			
		2. Recovery: At least 2 hours of recovery under the			
		standard condition after the test, followed by the			
		measurement within 24 ±2 hours.			
	Inductance change:	1. First -55°C for 30 minutes, last 125°C for 30			
	Within ± 10% Without distinct damage	minutes as 1 cycle. Go through 1000 cycles.			
Thermal Shock	in appearance	2. Max transfer time is 2 minutes.			
		3. Measured at room temperature after placing for			
		24±2 hours			
	Inductance change:	1.Reflow 2 times,			
Humidity	Within ± 10% Without distinct damage	2.85℃,85%RH,1000 hours			
Resistance	in appearance	3.Measured at room temperature after placing for			
		24±2 hours			
Low	Inductance change:	1. Temperature: -55 ± 2 ℃			
temperature	Within ± 10% Without distinct damage	2. Time: 1000 hours			
storage	in appearance	3. Measured at room temperature after placing for			
Storage		24±2 hours			
	Inductance change:	1. Temperature: +125 ± 2℃			
High	Within ± 10% Without distinct damage	2. Time: 1000 hours			
temperature	in appearance	3. Measured at room temperature after placing for			
storage		24±2 hours			

Rev.01 Page 3 of 7 www.cybermaxtech.com.cn



	Inductance change:	1、Run through IR reflow for 2 times;
	Within ± 10% Without distinct damage	2. Place the 100mm X 40mm board into a fixture
	in appearance	similar to the one shown in below Figure with the
		component facing down
		3. The apparatus shall consist of mechanical means
		to apply a force which will bend the board (D) x = 2
		mm minimum.
		4. The duration of the applied forces shall be 60±5
Board Flex		sec. The force is to be applied only once to the oard.
		Support Solder Chip Printed circuit board before to
		Printed circuit board under test  Printed circuit board under test  Displacement
	No removal or split of the termination or	1. The test samples shall be soldered to the board
	other defects shall occur.	2. Push the product vertically from the side of the
		sample using the thrust tester.
		3、Automotive electronics: 17.7N,60S±1s,X,
Terminal		Ydirect.
Strength		X direct
		Y direct

Rev.01 Page 4 of 7 www.cybermaxtech.com.cn



### **♦** Recommended Soldering Technologies

### (1) Re-flowing Profile

Preheat condition: 150 ~200 °C/60~180sec.

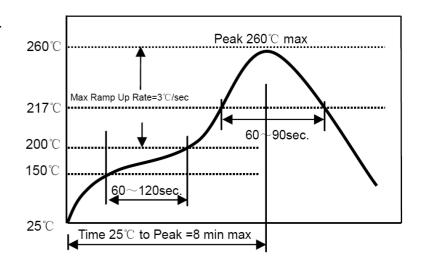
Allowed time above 217°C: 80~120sec.

Max temp: 260°C

Max time at max temp: 10 sec.

Solder paste: Sn/3.0Ag/0.5Cu

Allowed Reflow time: 2x max



### (2) Iron Soldering Profile

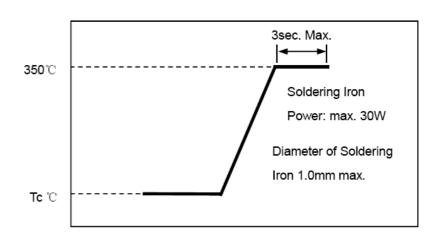
Iron soldering power: Max. 30W

Pre-heating: 150 °C/60sec.

Soldering time: 3sec. Max.

Solder paste: Sn/3.0Ag/0.5Cu

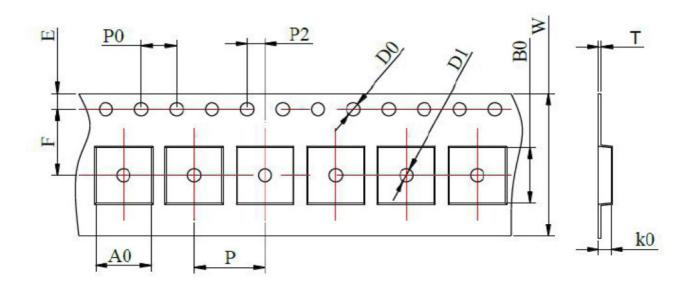
Max.1 times for iron soldering





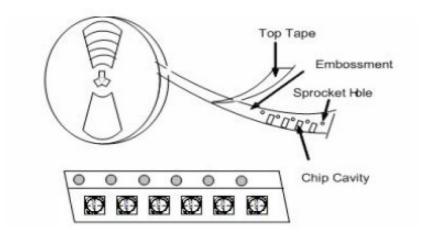
## **◆**Packaging Information

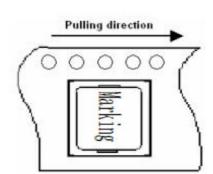
(1) Tape Packaging Dimensions (Unit: mm)



Туре	Tape dimensions (mm)											
	W	Р	P0	P2	D0	D1	Т	A0	В0	K0	E	F
CMLO0530	12 ±0.3	8 ±0.1	4 ±0.1	2 ±0.1	1.5 ±0.1	1.5 ±0.1	0.35 ±0.05	4.5 ±0.1	4.85 ±0.1	1.5 ±0.1	1.75 ±0.1	5.5 ±0.1

#### Taping Drawings (UNIT:mm)

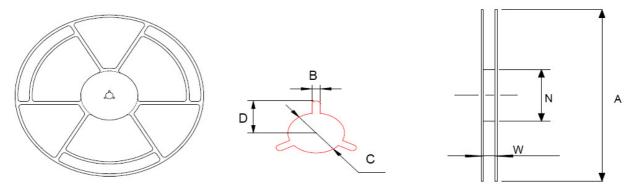




Rev.01 Page 6 of 7 www.cybermaxtech.com.cn



#### (2) Reel Dimensions (Unit: mm)



А	w	N	В	С	О
330+2.0	12.8±0.2	97±0.5	2.2+0.5	13.0±0.2	10.75±0.25

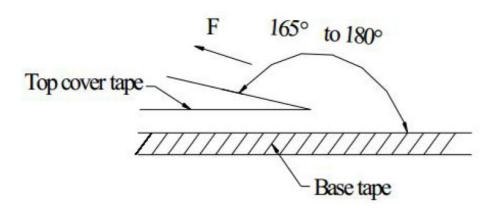
#### (3) Packaging Quantity(PCS)

Tymo	Standard Quantity						
Туре	Reel	Inner box	Carton box				
CMLO0530	2000 pcs/reel	4Reel/box(8000pcs)	4 Middle boxes, (32,000pcs)				

#### (4) Peel force of top cover tape

The peel speed shall be about 300mm/minute

The peel force of top cover tape shall be between 0.1 to 1.3 N



Rev.01 Page 7 of 7 www.cybermaxtech.com.cn